

DESCRIPTION

The AMC8878/8879 series is a low noise, low dropout linear regulator operating from 2.5V to 6.5V input. An external capacitor can be connected to the bypass pin to lower the output noise level to $30\mu V_{RMS}$.

Designed with a P-channel MOSFET output transistor, the AMC8878/8879 consume a low supply current, independent of the load current and dropout voltage. The internal thermal shut down circuit will limits the junction temperature to below 150°C. Other features include thermal protection, reverse battery protection and output current limit. Both AMC8878 and AMC8879 come in a miniature 5-pin SOT-23 package.

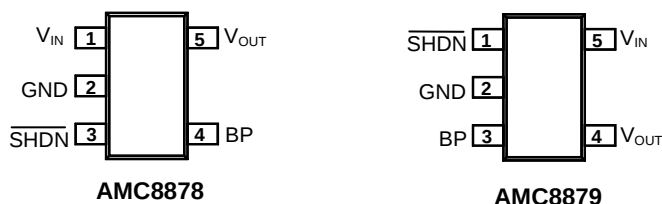
FEATURES

- Low output noise: $30\mu V_{RMS}$
- Industry standard'2982 pin assignment (AMC8878)
- Output voltage precision of $\pm 1.4\%$ accuracy
- Very low dropout voltage: 50mV/50mA and 165mV/150mA
- On/Off control
- Low I_Q : 1.6 μA
- Short circuit protection
- Internal thermal overload protection
- Available in surface mount 5-pin SOT-23 package.
- Enhanced pin-to-pin Compatible to the MAX8878 (AMC8878) and TK111xxS (AMC8879) series.

APPLICATIONS

- Cellular Telephones
- Battery Powered Systems
- Hand-Held Instruments
- Pagers
- Personal Data Assistance (PDA)
- PCMCIA Cards

PACKAGE PIN OUT



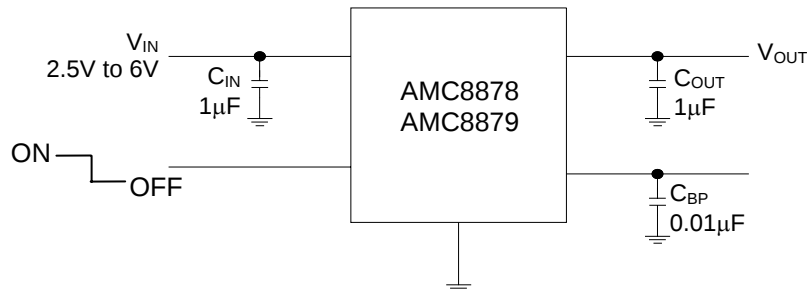
5-Pin Plastic SOT-23
Surface Mount
(Top View)

ORDER INFORMATION

Temperature Range	DBT	Plastic SOT-23	DBT	Plastic SOT-23
		5-pin		5-pin
$0^{\circ}C \leq T_A \leq 70^{\circ}C$		AMC8878-X.XDBT		AMC8879-X.XDBT
$0^{\circ}C \leq T_A \leq 70^{\circ}C$		AMC8878-X.XDBTF(Lead Free)		AMC8879-X.XDBTF(Lead Free)

EXPANDED ORDER INFORMATION

Device Name	Output Voltage	Symbolization	
		AMC8878	AMC8879
AMC887ف1.8DBT	1.8V	AB18	AC18
AMC887ف2.0DBT	2.0V	AB20	AC20
AMC887ف2.5DBT	2.5V	AB25	AC25
AMC887ف2.8DBT	2.8V	AB28	AC28
AMC887ف2.85DBT	2.85V	AB2U	AC2U
AMC887ف3.0DBT	3.0V	AB30	AC30
AMC887ف3.2DBT	3.2V	AB32	AC32
AMC887ف3.3DBT	3.3V	AB33	AC33
AMC887ف5.0DBT	5.0V	AB50	AC50

TYPICAL APPLICATION

ABSOLUTE MAXIMUM RATINGS (Note)

Input Voltage, V_{IN}	12V
Operating Junction Temperature, T_J	150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10 seconds)	+260°C
Power Dissipation, P_D @ $T_A = 70^\circ\text{C}$	150 mW
Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of the specified terminal.	

THERMAL DATA
DB PACKAGE:

Thermal Resistance from Junction to Ambient, θ_{JA}	220°C/W
Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$. The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system. Connect the ground pin to ground using a large pad or ground plane for better heat dissipation. All of the above assume no ambient airflow.	

Maximum Power Calculation:

$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_{A(MAX)}}{\theta_{JA}}$$

$T_J(^{\circ}\text{C})$: Maximum recommended junction temperature

$T_A(^{\circ}\text{C})$: Ambient temperature of the application

$\theta_{JA}(^{\circ}\text{C/W})$: Junction-to-junction temperature thermal resistance of the package, and other heat dissipating materials.

The maximum power dissipation for a single-output regulator is :

$$P_{D(MAX)} = [(V_{IN(MAX)} - V_{OUT(NOM)}) \times I_{OUT(NOM)} + V_{IN(MAX)} \times I_Q]$$

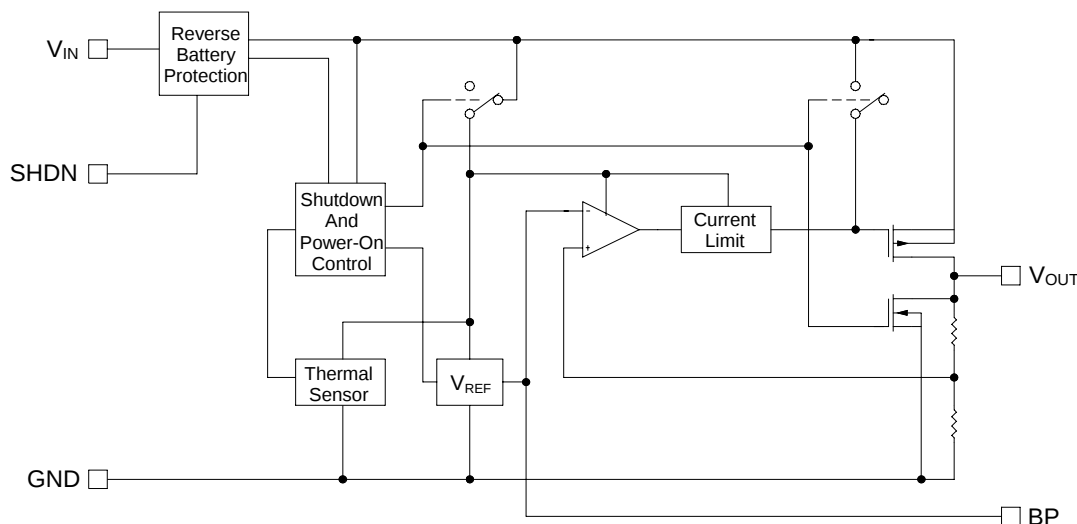
Where: $V_{OUT(NOM)}$ = the nominal output voltage

$I_{OUT(NOM)}$ = the nominal output current, and

I_Q = the quiescent current the regulator consumes at $I_{OUT(MAX)}$

$V_{IN(MAX)}$ = the maximum input voltage

Then $\theta_{JA} = (+150^{\circ}\text{C} - T_A)/P_D$

BLOCK DIAGRAM

PIN DESCRIPTION

Pin Number		Pin Name	Pin Function
AMC8878	AMC8879		
1	5	V _{IN}	Input
2	2	GND	Ground
3	1	$\overline{\text{SHDN}}$	Logic control shutdown pin; HI: Device is ON, LO: Device is OFF
4	3	BP	Noise bypass pin; The output noise level can be reduced to 30 μ V _{RMS} by connecting external capacitors
5	4	V _{OUT}	Output

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Recommended Operating Conditions			Units
		Min.	Typ.	Max.	
Input Voltage	V _{IN}	2.5		6.5	V
Load Current	I _O	5		150	mA
Input Capacitor (V _{IN} to GND)		1.0			μ F
Output Capacitor with ESR of 10 Ω max., (V _{OUT} to GND)		1.0			μ F

Note:

1. C_{IN}: A 1.0 μ F capacitor (or larger) should be placed between V_{IN} to GND.
2. C_{OUT}: A 1.0 μ F (or larger) capacitor is recommended between V_{OUT} and GND for stability and improving the regulator's transient response. The ESR (Effective Series Resistance) of this capacitor has no effect on regulator stability, but low ESR capacitors improve high frequency transient response. The value of this capacitor may be increased without limit, but values larger than 10 μ F tend to increase the settling time after a step change in input voltage or output current. The part may oscillate without the capacitor. Any type of capacitor can be used, but not Aluminum electrolytics when operating below -25°C, The capacitance may be increased without limit.

ELECTRICAL CHARACTERISTICS

Unless otherwise specified, these specifications apply over the operating ambient temperature of 0°C to +70°C with $V_{IN} = V_{OUT(NOMIAL)} + 0.5V$, and are for DC characteristics only. (Low duty cycle pulse testing techniques are used which maintains junction and case temperatures equal to the ambient temperature.)

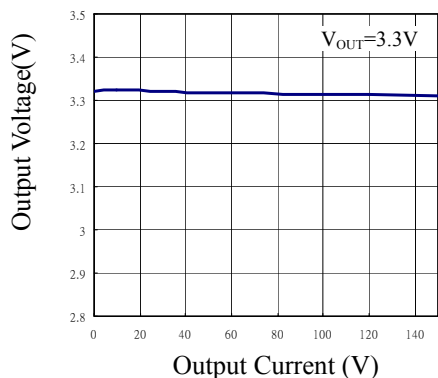
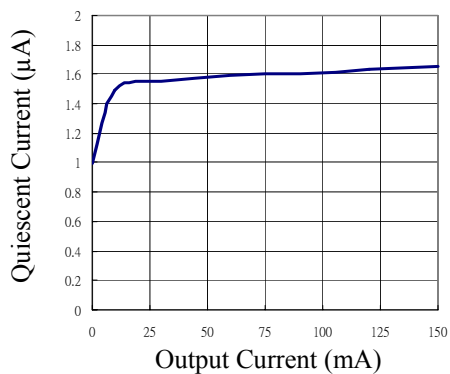
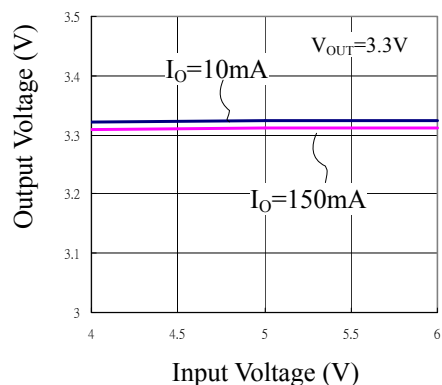
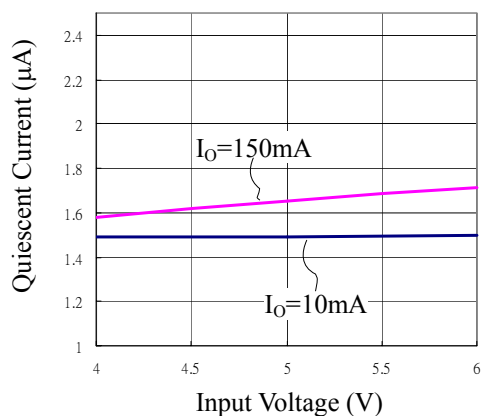
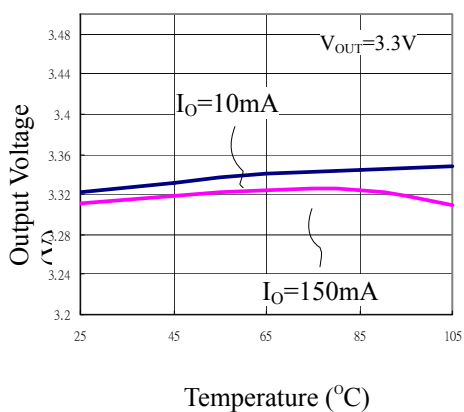
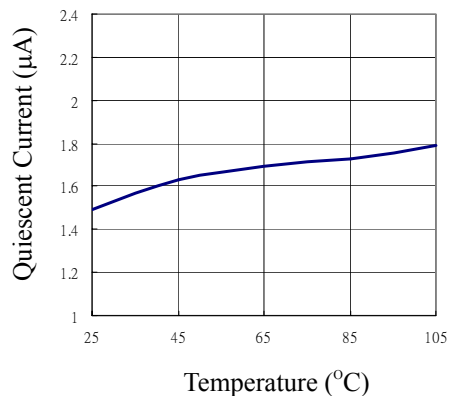
Parameter	Symbol	Test Conditions	AMC8878/8879			Units
			Min	Typ.	Max	
Output Voltage Accuracy	ΔV_{OUT}	$I_{OUT} = 10mA, T_A = +25^\circ C$	-1.4		+1.4	%
		$I_{OUT} = 10 \text{ to } 150mA$	-3		+2	
Maximum Output Current	I_{OUT}		150			mA
Current Limit	I_{LIMIT}		160			mA
Ground Pin Current	I_Q	$I_{OUT} = 10mA$		1.6	10	μA
		$I_{OUT} = 150mA$		1.7		
Dropout Voltage	V_{DROP}	$I_{OUT} = 1mA$		1.1		mV
		$I_{OUT} = 50mA$		50	120	
		$I_{OUT} = 150mA$		165		
Line Regulation	ΔV_{OI}	$V_{IN} = (V_{OUT} + 0.1V) \text{ to } 6.5V, I_{OUT} = 1mA$	-0.15	0	0.15	%/V
Load Regulation	ΔV_{OL}	$I_{OUT} = 10 \text{ to } 120mA, C_{OUT} = 1\mu F$		0.01	0.04	%/mA
Ripple Rejection	PSRR	$f=100Hz, I_L=100\mu A$		50		dB
Output Voltage Noise	e_n	$f = 10Hz - 100KHz, C_{OUT} = 10\mu F$		30		μV_{RMS}
		$C_{BP} = 0.01\mu F, C_{OUT} = 100\mu F$		20		
Shutdown Input Threshold High	V_{SIH}	$V_{IN} = 2.5V \text{ to } 5.5V$	2.0			V
Shutdown Input Threshold Low	V_{SIL}	$V_{IN} = 2.5V \text{ to } 5.5V$			0.4	V
Shutdown Supply Current	$I_{Q(SHDN)}$	$V_{OUT} = 0V$	$T_A = +25^\circ C$	0.01	1	μA
			$T_A = +85^\circ C$	0.2		
Shutdown Input Bias Current	I_{SHDN}	$\overline{V_{SHDN}} = V_{IN}$	$T_A = +25^\circ C$	0.01	100	nA
			$T_A = +85^\circ C$	0.5		
Shutdown Exit Delay	t_{delay}	$C_{BP} = 0.1\mu F, C_{OUT} = 1\mu F, \text{ No load}$	$T_A = +25^\circ C$	6		ms
			$T_A = +85^\circ C$	6		
Thermal Shutdown Temperature	T_{SHDN}			+150		$^\circ C$

Note:

1. Current limit is measured at constant junction temperature, using pulse ON time.
2. Dropout is measured at constant junction temperature, using pulse ON time, and criterion is V_{OUT} inside target value $\pm 2\%$.
3. Regulation is measured at constant junction temperature, using pulsed ON time.

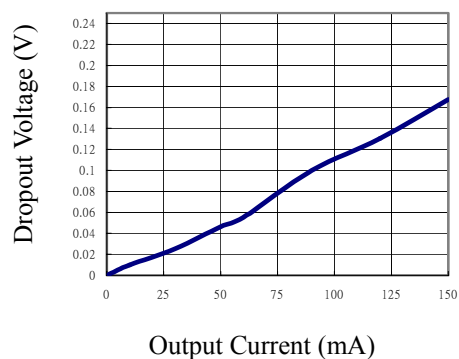
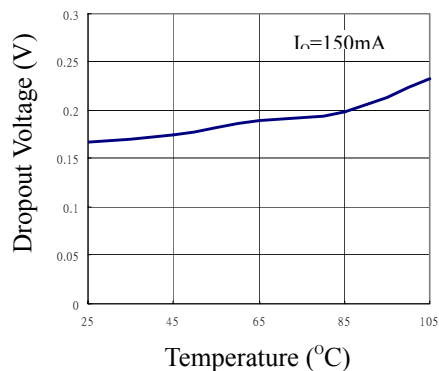
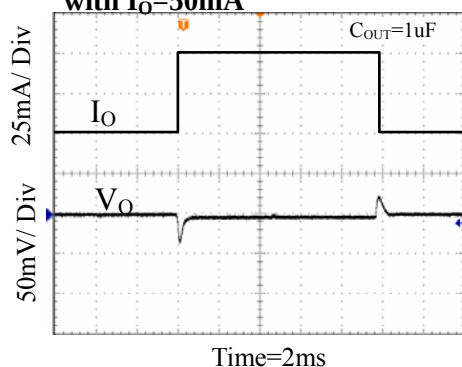
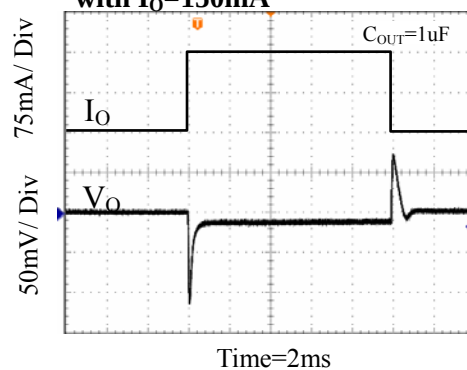
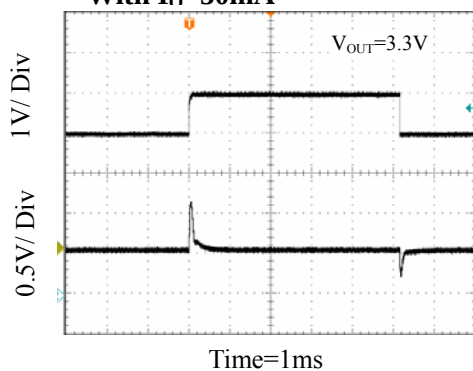
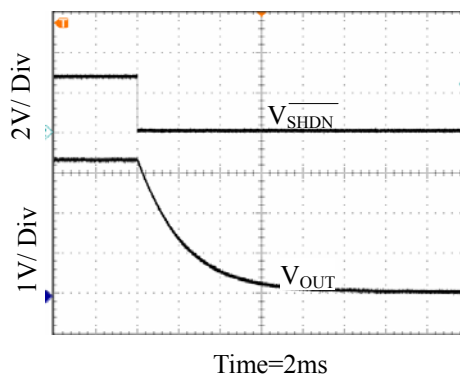
CHARACTERIZATION CURVES

$V_{IN} = V_{OUT(NOMINAL)} + 0.5V$ or $2.5V$ (whichever is greater), $C_{IN} = 1\mu F$, $C_{OUT} = 1\mu F$, $C_{BP} = 0.01\mu F$, $T_A = +25^\circ C$,
Using pulsed ON time, unless otherwise noted.

Output Voltage v.s. Output Current

Quiescent Current v.s. Output Current

Output Voltage v.s. Input Voltage

Quiescent Current v.s. Input Voltage

Output Voltage v.s. Temperature

Quiescent Current v.s. Temperature


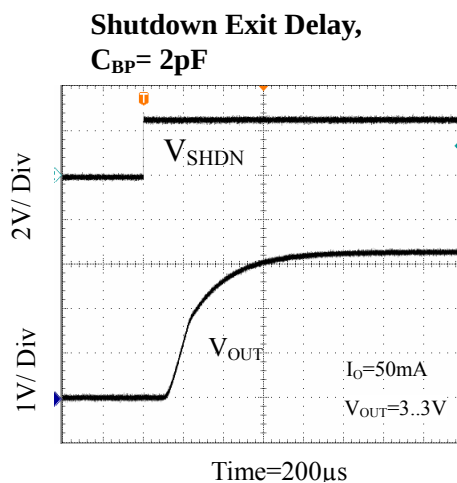
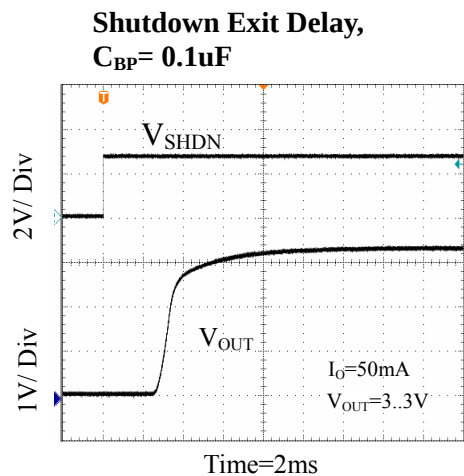
CHARACTERIZATION CURVES (Continued)

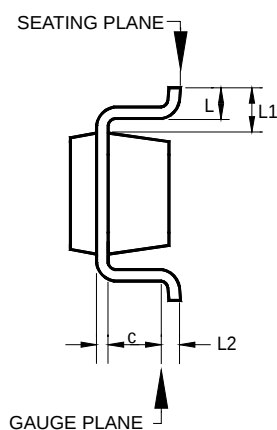
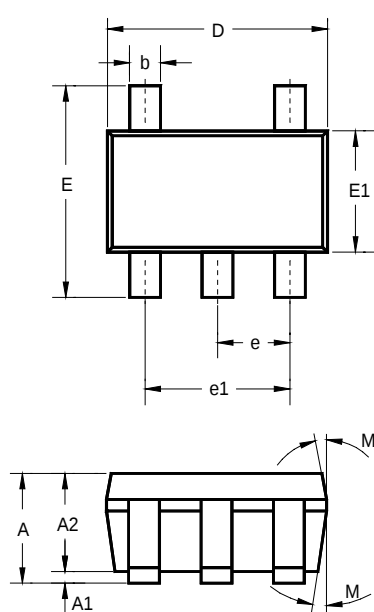
$V_{IN} = V_{OUT(NOMINAL)} + 0.5V$ or $2.5V$ (whichever is greater), $C_{IN} = 1\mu F$, $C_{OUT} = 1\mu F$, $C_{BP} = 0.01\mu F$, $T_A = +25^\circ C$,
Using pulsed ON time, unless otherwise noted.

Dropout Voltage v.s. Output Current

Dropout Voltage v.s. Temperature

**Load Transient Response
with $I_O = 50mA$**

**Load Transient Response
with $I_O = 150mA$**

**Line Transient Response,
With $I_O = 50mA$**

**Entering Shutdown,
No Load**


CHARACTERIZATION CURVES (Continued)

$V_{IN}=V_{OUT(NOMINAL)} + 0.5V$ or $2.5V$ (whichever is greater), $C_{IN}=1\mu F$, $C_{OUT}=1\mu F$, $C_{BP}=0.01\mu F$, $T_A=+25^\circ C$,
Using plused ON time, unless otherwise noted.



PACKAGE
5-Pin SOT-23


	INCHES			MILLIMETERS		
	MIN	TYP	MAX	MIN	TYP	MAX
A	-	-	0.057	-	-	1.45
A1	-	-	0.006	-	-	0.15
A2	0.035	0.045	0.051	0.90	1.15	1.30
b	0.012	-	0.020	0.30	-	0.50
c	0.003	-	0.009	0.08	-	0.22
D	0.114 BSC			2.90 BSC		
E	0.110 BSC			2.80 BSC		
E1	0.063 BSC			1.60 BSC		
e	0.037 BSC			0.95 BSC		
e1	0.075 BSC			1.90 BSC		
L	0.012	0.018	0.024	0.30	0.45	0.60
L1	0.024 REF			0.60 REF		
L2	0.010 BSC			0.25 BSC		
°M	5°	10°	15°	5°	10°	15°

IMPORTANT NOTICE

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ADDtek Corp.

9F, No. 20, Sec. 3, Bade Rd., Taipei, Taiwan, 105

TEL: 2-25700299

FAX: 2-25700196
